MAX16832A/MAX16832C

2MHz, High-Brightness LED Drivers with Integrated MOSFET and High-Side Current Sense

Absolute Maximum Ratings

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IN, CS, LX, DIM to GND	0.3V to +70V
TEMP_I to GND	0.3V to +6V
PGND to GND	0.3V to +0.3V
CS to IN	0.3V to +0.3V
Maximum Current into Any Pin	
(except IN, LX, and PGND)	20mA
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
8-Pin SO (derate 18.9mW/°C above +70°C	C)1509.4mW

Operating Temperature Range	
700mA (max) Output Current	40°C to +125°C
1A (max) Output Current	40°C to +105°C
Junction Temperature	+150°C
Storage Temperature Range	
Soldering (reflow)	+260°C
Lead Temperature (soldering, 10s)	
Pin-to-Pin ESD Ratings	±2.5kV

Package Thermal Characteristics (Note 1)

SO-EP

Junction-to-Ambient Thermal Resistance (θJA).....+53°C/W Junction-to-Case Thermal Resistance (θ_{JC}).....+5°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

 $(V_{IN} = +24V, V_{DIM} = V_{IN}, T_A = T_J = -40$ °C to +125°C, unless otherwise noted. Typical values are at $T_A = +25$ °C.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	VIN		6.5		65	V
Ground Current		No switching		1.5		mA
Supply Current		$V_{DIM} < 0.6V, V_{IN} = 12V$		350		μΑ
UNDERVOLTAGE LOCKOUT (UV	LO)					
Undervoltege Leekeut	UVLO	V _{CS} = V _{IN} - 100mV, V _{IN} rising until V _{LX} < 0.5V _{IN}		6.25	6.5	\/
Undervoltage Lockout	UVLO	$V_{CS} = V_{IN}$ - 100mV, V_{IN} falling until $V_{LX} > 0.5V_{IN}$			6.0	V
Undervoltage-Lockout Hysteresis				0.5		V
SENSE COMPARATOR						
Sense Voltage Threshold High	V.	MAX16832A, V_{IN} - V_{CS} rising from 140mV until $V_{LX} > 0.5V_{IN}$, $V_{DIM} = 5V$	197	205	213	- mV
		MAX16832C, V_{IN} - V_{CS} rising from 140mV until $V_{LX} > 0.5V_{IN}$, $V_{DIM} = 5V$	218	230	236	
Sense Voltage Threshold Low	Maria	MAX16832A, V_{IN} - V_{CS} falling from 260mV until V_{LX} < 0.5 V_{IN} , V_{DIM} = 5 V	185	190	198	>/
	Vsnslo	MAX16832C, V _{IN} - V _{CS} falling from 260mV until V _{LX} < 0.5V _{IN} , V _{DIM} = 5V	166	170	180	- mV
Propagation Delay to Output High	tDPDH	Falling edge of V _{IN} - V _{CS} from 140mV to 260mV to V _{LX} > 0.5V _{IN}		50		ns
Propagation Delay to Output Low	tDPDL	Rising edge of V_{CS} - V_{IN} from 260mV to 140mV to V_{LX} < 0.5 V_{IN}		50		ns
CS Input Current	ICSIN	V _{IN} - V _{CS} = 200mV, V _{IN} = V _{CS}		•	3.5	μΑ

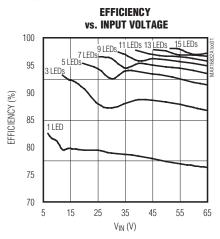
Electrical Characteristics (continued)

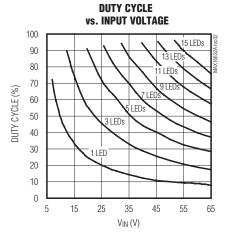
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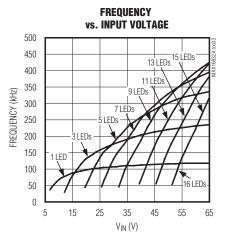
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
INTERNAL MOSFET		·				
Duain to Course Desistance	Deservi	$V_{IN} = V_{DIM} = 24V$, $V_{CS} = 23.9V$, $I_{LX} = 700$ mA		0.45	0.9	
Drain-to-Source Resistance	RDSON	$V_{IN} = V_{DIM} = 6.0V$, $V_{CS} = 5.9V$, $I_{LX} = 700$ mA		1	2	Ω
LX Leakage Current	ILX_LEAK	$V_{DIM} = 0V$, $V_{LX} = 65V$			10	μΑ
DIM INPUT						
DIM Input-Voltage High	VIH	V _{IN} - V _{CS} = 100mV	2.8			V
DIM Input-Voltage Low	VIL	$V_{CS} - V_{IN} = 100 \text{mV}$			0.6	V
DIM Turn-On Time	tDIM_ON	V_{DIM} rising edge to $V_{LX} < 0.5V_{IN}$		60		ns
DIM Input Leakage High		$V_{DIM} = V_{IN}$		8	15	μΑ
DIM Input Leakage Low		V _{DIM} = 0V	-3	-1.5	0	μΑ
THERMAL SHUTDOWN		•				
Thermal-Shutdown Threshold		Temperature rising		+165		°C
Thermal-Shutdown Threshold Hysteresis				10		°C
THERMAL FOLDBACK	•		•			
Thermal-Foldback Enable Threshold Voltage	V _{TFB} ON	V _{DIM} = 5V	1.9	2.0	2.12	V
Thermal-Foldback Slope	FB _{SLOPE}	V _{DIM} = 5V		0.75		1/V
TEMP_I Output Bias Current	ITEMP_I	T _A = +25 °C	25	26.5	28	μΑ

Typical Operating Characteristics

 $(V_{IN} = V_{DIM} = 48V, R_{SENSE} = 0.3\Omega, L = 220\mu H$ (connected between IN and CS). Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.)



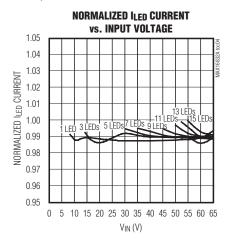


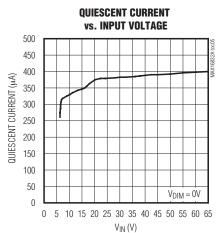


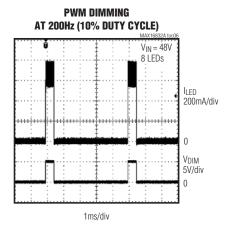
2MHz, High-Brightness LED Drivers with Integrated MOSFET and High-Side Current Sense

Typical Operating Characteristics (continued)

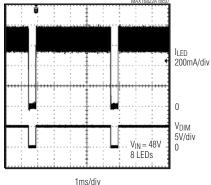
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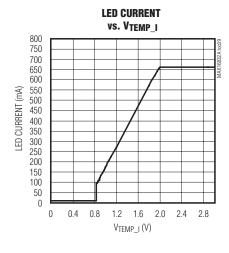




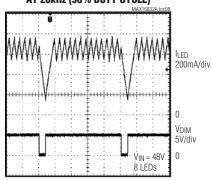




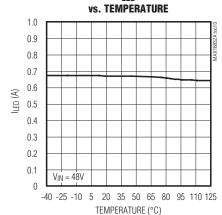




PWM DIMMING AT 20kHz (90% DUTY CYCLE)



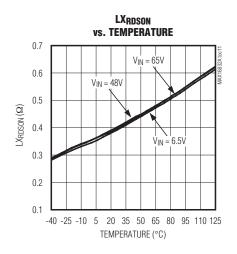
10µs/div

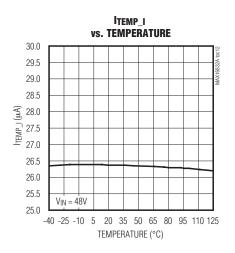


2MHz, High-Brightness LED Drivers with Integrated MOSFET and High-Side Current Sense

Typical Operating Characteristics (continued)

 $(V_{IN} = V_{DIM} = 48V, R_{SENSE} = 0.3\Omega, L = 220\mu H$ (connected between IN and CS). Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.)





Pin Description

PIN	NAME	FUNCTION
1	CS	Current-Sense Input. Connect a resistor between IN and CS to program the LED current.
2	IN	Positive Supply Voltage Input. Bypass with a 1µF or higher value capacitor to GND.
3	GND	Ground
4	PGND	Power Ground
5, 6	LX	Switching Node
1 / I DIM I		Logic-Level Dimming Input. Drive DIM low to turn off the current regulator. Drive DIM high to enable the current regulator.
8	TEMP_I	Thermal Foldback Control and Linear Dimming Input. Bypass with a 0.01µF capacitor to GND if thermal foldback or analog dimming is used. See the <i>Thermal Foldback</i> section.
_	EP	Exposed Pad. Connect EP to a large-area ground plane for effective power dissipation. Do not use as the IC ground connection.

Detailed Description

The MAX16832A/MAX16832C are step-down, constant-current, HB LED drivers. These devices operate from a +6.5V to +65V input voltage range. The maximum output is 1A, if the part is used at temperatures up to T_A = $+105^{\circ}$ C, or 700mA, if it is used up to T_A = $+125^{\circ}$ C. A high-side current-sense resistor sets the output current

and a dedicated PWM dimming input enables pulsed LED dimming over a wide range of brightness levels.

A high-side current-sensing scheme and an on-board current-setting circuitry minimize the number of external components while delivering LED current with $\pm 3\%$ accuracy, using a 1% sense resistor. See Figure 1 for a functional diagram.

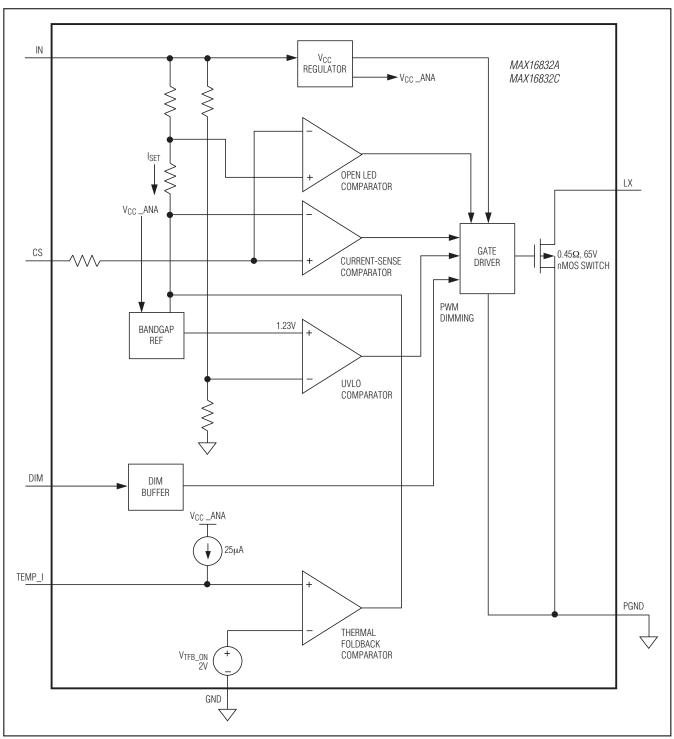


Figure 1. Functional Diagram

MAX16832A/MAX16832C

2MHz, High-Brightness LED Drivers with Integrated MOSFET and High-Side Current Sense

Undervoltage Lockout (UVLO)

The MAX16832A/MAX16832C include a UVLO with 500mV hysteresis. The internal MOSFET turns off when V_{IN} falls below 5.5V to 6.0V.

DIM Input

LED dimming is achieved by applying a PWM signal at DIM. A logic level below 0.6V at DIM forces the MAX16832A/MAX16832Cs' output low, thus turning off the LED current. To turn the LED current on, the logic level at DIM must be greater than 2.8V.

Thermal Shutdown

The MAX16832A/MAX16832C thermal-shutdown feature turns off the LX driver when the junction temperature exceeds +165°C. The LX driver turns back on when the junction temperature drops 10°C below the shutdown temperature threshold.

Analog Dimming

The MAX16832A/MAX16832C offer an analog-dimming feature that reduces the output current when the voltage at TEMP_I is below the internal 2V threshold voltage. The MAX16832A/MAX16832C achieve analog dimming by either an external DC voltage source connected between TEMP_I and ground or by a voltage on a resistor connected across TEMP_I and ground induced by an internal current source of 25µA. When the voltage at TEMP_I is below the internal 2V threshold limit, the MAX16832A/MAX16832C reduce the LED current. Use the following formula to set the analog dimming current:

$$I_{TF}(A) = I_{LED}(A) \times \left[1 - FB_{SLOPE} \left(\frac{1}{V} \right) \times \left(V_{TFB_ON} - V_{AD} \right) (V) \right]$$

where $V_{TFB_ON} = 2V$ and $FB_{SLOPE} = 0.75$ are obtained from the *Electrical Characteristics* table and V_{AD} is the voltage at TEMP_I.

Thermal Foldback

The MAX16832A/MAX16832C include a thermal-fold-back feature that reduces the output current when the temperature of the LED string exceeds a specified temperature point. These devices enter thermal-foldback mode when the voltage drop on the NTC thermistor, thermally attached to the LEDs and electrically connected between TEMP_I and ground, drops below the internal 2V threshold limit.

Applications Information

Selecting R_{SENSE} to Set LED Current

The LED current is programmed with a current-sense resistor connected between IN and CS. Use the following equation to calculate the value of this resistor:

$$R_{SENSE}(\Omega) = \frac{1}{2} \frac{(V_{SNSHI} + V_{SNSLO})(V)}{I_{I,ED}(A)}$$

where V_{SNSHI} is the sense voltage threshold high and V_{SNSLO} is the sense voltage threshold low (see the *Electrical Characteristics* table for values).

Current-Regulator Operation

The MAX16832A/MAX16832C regulate the LED current using a comparator with hysteresis (see Figure 2). As the current through the inductor ramps up and the voltage across the sense resistor reaches the upper threshold, the internal MOSFET turns off. The internal MOSFET turns on again when the inductor current ramps down through the freewheeling diode until the voltage across the sense resistor equals the lower threshold. Use the following equation to determine the operating frequency:

$$f_{SW} = \frac{(V_{IN} - nV_{LED}) \times nV_{LED} \times R_{SENSE}}{V_{IN} \times \Delta V \times L}$$

where n is the number of LEDs, V_{LED} is the forward voltage drop of 1 LED, and $\Delta V = (V_{SNSHI} - V_{SNSLO})$.

Inductor Selection

The MAX16832A/MAX16832C operate up to a switching frequency of 2MHz. For space-sensitive applications, the high switching frequency allows the size of the inductor to be reduced. Use the following formula to calculate an approximate inductor value and use the closest standard value:

$$L(approx.) = \frac{(V_{IN} - nV_{LED}) \times nV_{LED} \times R_{SENSE}}{V_{IN} \times \Delta V \times f_{SW}}$$

For component selection, use the MAX16832A/C Design Tool available at: www.maximintegrated.com/MAX16832-software.

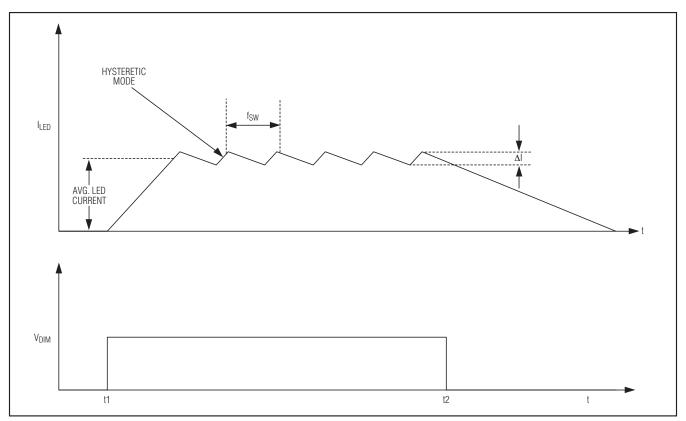


Figure 2. Current-Regulator Operation

Freewheeling-Diode Selection

For stability and best efficiency, a low forward-voltage drop diode with fast reverse-recovery time and low capacitance is recommended. A Schottky diode is a good choice as long as its breakdown voltage is high enough to withstand the maximum operating voltage.

PCB Layout Guidelines

Careful PCB layout is critical to achieve low switching losses and stable operation. In normal operation, there are two power loops. One is formed when the internal MOSFET is on and the high current flows from ground through the input cap, RSENSE, the LED load, the inductor, and the internal MOSFET back to ground. The second loop is formed when the internal MOSFET is off and the high current circulates from the input cap positive terminal through RSENSE, the LED load, the inductor, and the freewheeling diode and back to the input cap positive terminal. Note that the current through RSENSE, the LED load, and the inductor is basically DC with some triangular ripple (low noise). The high-noise, large signal, fast transition switching currents only flow through the freewheeling diode to the input cap positive

terminal, or through the MOSFET to ground and then to the input cap positive terminal. Without a proper PCB layout, these square-wave switching currents can create problems in a hysteretic LED driver.

The current control depends solely on the voltage across Rsense. Any noise pickup on this node induces erratic switching of the internal MOSFET (the IC will operate at a much higher frequency). To help prevent this, place RSENSE as close as possible to CS and IN and keep the sense traces short. It is especially important to keep the square-wave switching currents in the freewheeling diode away from RSFNSF. To minimize interference, place the freewheeling diode on the opposite side of the IC as RSENSE and position the input capacitor near the diode so it can return the high frequency currents to ground. The layout in Figure 3 should be used as a guideline. The dashed line shows the path of the high frequency components that cause disruption in operation. For a good thermal design, the exposed pad on the IC should solder to a large pad with many vias to the backside ground plane.

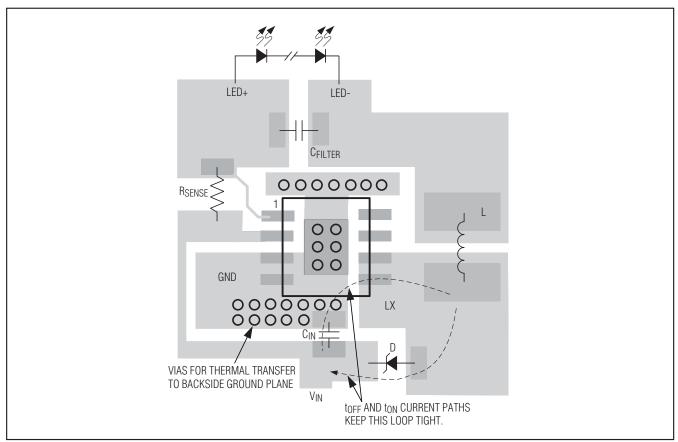
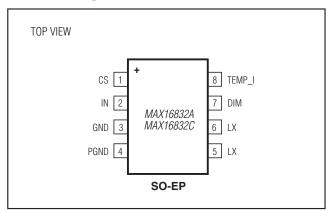


Figure 3. PCB Layout

Pin Configuration



Chip Information

PROCESS: BICMOS

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX16832AASA+	-40°C to +125°C	8 SO-EP*
MAX16832AASA/V+	-40°C to +125°C	8 SO-EP*
MAX16832CASA+	-40°C to +125°C	8 SO-EP*

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

/V denotes an automotive qualified part.

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/package. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
8 SO-EP	S8E-12	<u>21-0111</u>	<u>90-0150</u>

^{*}EP = Exposed pad.

MAX16832A/MAX16832C

2MHz, High-Brightness LED Drivers with Integrated MOSFET and High-Side Current Sense

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	5/08	Initial release	_
1	9/08	Introduced the MAX16832C	1
2	5/09	Revised General Description, Features, Absolute Maximum Ratings, and Detailed Description	1, 2, 5
3	2/10	Updated PCB Layout Guidelines and added Figure 3	8, 9
4	8/10	Corrected Functional Diagram and added Soldering (reflow) to Absolute Maximum Ratings	2, 5, 6
5	3/12	Updated Sense Voltage Threshold High and DIM Turn-On Time in <i>Electrical Characteristics</i>	2, 3
6	7/12	Added automotive qualified part to Ordering Information	1
7	2/15	Updated Applications and Benefits and Features sections	1

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